



**THE DATASHEET OF
BZD27C7V5P RVG**



1W, 6.8V - 220V Voltage Regulator Diode

FEATURES

- Silicon zener diodes
- Low profile surface-mount package
- Zener and surge current specification
- Low leakage current
- Excellent stability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

KEY PARAMETERS

PARAMETER	VALUE	UNIT
V_Z	6.8 - 220	V
P_{tot}	1.0	W
T_{JMAX}	175	°C
Package	Sub SMA	
Configuration	Single die	

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter



MECHANICAL DATA

- Case: Sub SMA
- Molding compound meets UL 94 V-0 flammability rating
- Part no. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Moisture sensitivity level: level 1, per J-STD-020
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 19mg (approximately)



Sub SMA

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	VALUE	UNIT
Forward voltage @ $I_F=0.2\text{A}$	V_F	1.2	Volts
Power dissipation at $T_L=73^\circ\text{C}$ $T_A=25^\circ\text{C}$ (Note 1)	P_{tot}	2.3	Watts
		1.0	
Non-repetitive peak pulse power dissipation 100 μs square pulse (Note 2)	P_{ZSM}	300	Watts
Non-repetitive peak pulse power dissipation 10/1000 μs waveform (BZD27C6V8P to BZD27C100P)	P_{RSM}	150	Watts
Non-repetitive peak pulse power dissipation 10/1000 μs waveform (BZD27C110P to BZD27C220P)	P_{RSM}	100	Watts
Operating and storage temperature range	T_J, T_{STG}	-55 to +175	°C

Notes:

1. Mounted on Cu-Pad size 5mm x 5mm
2. $T_J=25^\circ\text{C}$ prior to surge

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	44	$^{\circ}C/W$
Junction-to-ambient thermal resistance	$R_{\theta JA}$	88	$^{\circ}C/W$
Junction-to-case thermal resistance	$R_{\theta JC}$	48	$^{\circ}C/W$

Thermal Performance Note: Units mounted on recommended PCB (5mm x 5mm Cu pad test board)

ORDERING INFORMATION					
PART NO.	PARTNO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
BZD27CxxP (Note 1)	H	RU	G	Sub SMA	1,800 / 7" Plastic reel (8mm tape)
		RV		Sub SMA	3,000 / 7" Plastic reel (8mm tape)
		RT		Sub SMA	7,500 / 13" Paper reel (8mm tape)
		MT		Sub SMA	7,500 / 13" Plastic reel (8mm tape)
		RQ		Sub SMA	10,000 / 13" Paper reel (8mm tape)
		MQ		Sub SMA	10,000 / 13" Plastic reel (8mm tape)
		R3		Sub SMA	1,800 / 7" Plastic reel (12mm tape)
		RF		Sub SMA	3,000 / 7" Plastic reel (12mm tape)
		R2		Sub SMA	7,500 / 13" Paper reel (12mm tape)
		M2		Sub SMA	7,500 / 13" Plastic reel (12mm tape)
		RH		Sub SMA	10,000 / 13" Paper reel (12mm tape)
		MH		Sub SMA	10,000 / 13" Plastic reel (12mm tape)

Note :

- "xx" defines voltage from 6.8V (BZD27C6V8P) to 220V (BZD27C220P)

EXAMPLE					
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
BZD27C10PHRUG	BZD27C10P	H	RU	G	AEC-Q101 qualified Green compound

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)											
Part number	Marking code	Working Voltage (Note 1)			Differential Resistance		Temperature Coefficient		Test current	Reverse Current@ Reverse Voltage	
		$V_Z @ I_{ZT}$			$r_{diff} @ I_Z$		$ALPH_Z @ I_Z$		I_{ZT}	I_R	V_R
		V			Ω		%/°C		mA	μA	V
		Min.	Nom.	Max.	Typ.	Max.	Max.	Max.		Max.	
BZD27C6V8P	D7	6.4	6.8	7.2	1	3	0	0.07	100	10	3
BZD27C7V5P	D8	7.0	7.45	7.9	1	2	0	0.07	100	50	3
BZD27C8V2P	D9	7.7	8.2	8.7	1	2	0.03	0.08	100	10	3
BZD27C9V1P	E0	8.5	9.05	9.6	2	4	0.03	0.08	50	10	5
BZD27C10P	E1	9.4	10	10.6	2	4	0.05	0.09	50	7	7.5
BZD27C11P	E2	10.4	11	11.6	4	7	0.05	0.10	50	4	8.2
BZD27C12P	E3	11.4	12.05	12.7	4	7	0.05	0.10	50	3	9.1
BZD27C13P	E4	12.4	13.25	14.1	5	10	0.05	0.10	50	2	10
BZD27C15P	E5	13.8	14.7	15.6	5	10	0.05	0.10	25	1	11
BZD27C16P	E6	15.3	16.2	17.1	6	15	0.06	0.11	25	1	12
BZD27C18P	E7	16.8	17.95	19.1	6	15	0.06	0.11	25	1	13
BZD27C20P	E8	18.8	20	21.2	6	15	0.06	0.11	25	1	15
BZD27C22P	E9	20.8	22.05	23.3	6	15	0.06	0.11	25	1	16
BZD27C24P	F0	22.8	24.2	25.6	7	15	0.06	0.11	25	1	18
BZD27C27P	F1	25.1	27	28.9	7	15	0.06	0.11	25	1	20
BZD27C30P	F2	28	30	32	8	15	0.06	0.11	25	1	22
BZD27C33P	F3	31	33	35	8	15	0.06	0.11	25	1	24
BZD27C36P	F4	34	36	38	21	40	0.06	0.11	10	1	27
BZD27C39P	F5	37	39	41	21	40	0.06	0.11	10	1	30
BZD27C43P	F6	40	43	46	24	45	0.07	0.12	10	1	33
BZD27C47P	F7	44	47	50	24	45	0.07	0.12	10	1	36
BZD27C51P	F8	48	51	54	25	60	0.07	0.12	10	1	39
BZD27C56P	F9	52	56	60	25	60	0.07	0.12	10	1	43
BZD27C62P	G0	58	62	66	25	80	0.08	0.13	10	1	47
BZD27C68P	G1	64	68	72	25	80	0.08	0.13	10	1	51
BZD27C75P	G2	70	74.5	79	30	100	0.08	0.13	10	1	56
BZD27C82P	G3	77	82	87	60	200	0.08	0.13	10	1	62
BZD27C91P	G4	85	90.5	96	60	200	0.08	0.13	5	1	68
BZD27C100P	G5	94	100	106	60	200	0.09	0.13	5	1	75
BZD27C110P	G6	104	110	116	80	250	0.09	0.13	5	1	82
BZD27C120P	G7	114	120.5	127	150	300	0.09	0.13	5	1	91
BZD27C130P	G	124	132.5	141	150	300	0.09	0.13	5	1	100
BZD27C150P	G9	138	147	156	150	300	0.09	0.13	5	1	110
BZD27C160P	H0	153	162	171	150	350	0.09	0.13	5	1	120
BZD27C180P	H1	168	179.5	191	280	450	0.09	0.13	5	1	130
BZD27C200P	H2	188	200	212	350	750	0.09	0.13	5	1	150
BZD27C220P	H3	208	220.5	233	430	900	0.09	0.13	5	1	160

 Note 1: Pulse test: $t_p \leq 5\text{ms}$.

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 TYPICAL FORWARD CHARACTERISTICS

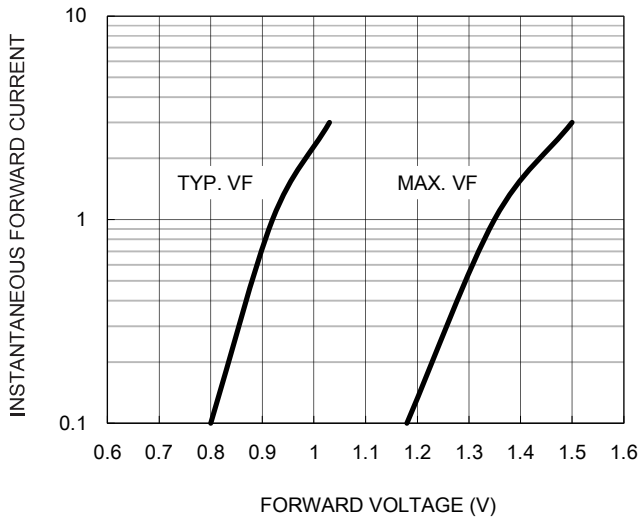


Fig.2 TYP. DIODE CAPACITANCE vs REVERSE VOLTAGE

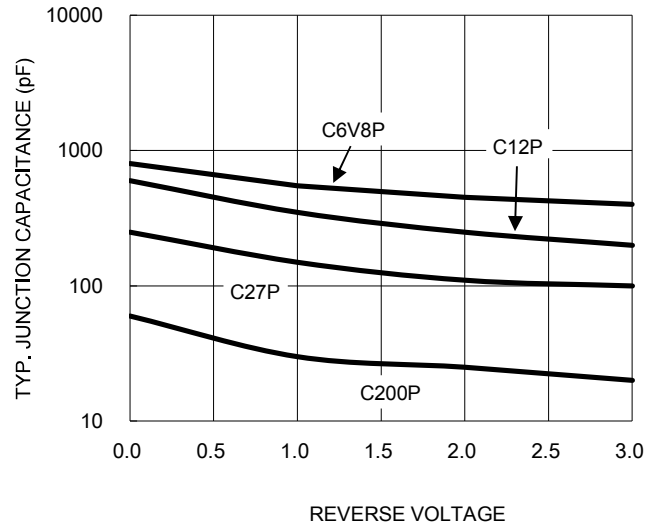
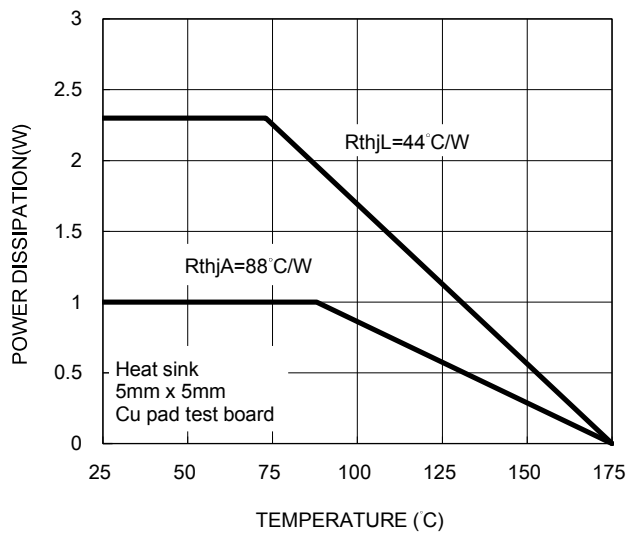
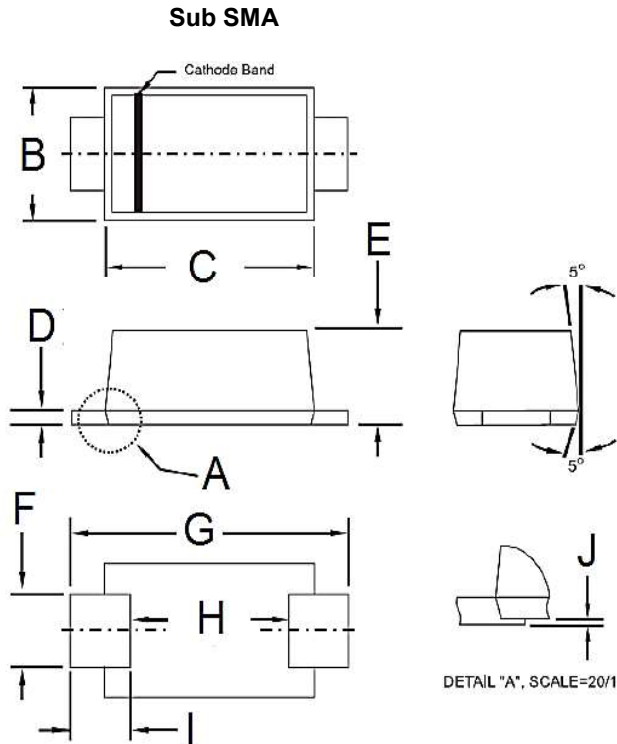


Fig.3 POWER DISSIPATION v.s TEMPERATURE

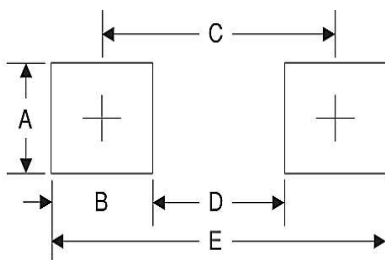


PACKAGE OUTLINE DIMENSIONS



DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
B	1.70	1.90	0.067	0.075
C	2.70	2.90	0.106	0.114
D	0.16	0.30	0.006	0.012
E	1.23	1.43	0.048	0.056
F	0.80	1.20	0.031	0.047
G	3.40	3.80	0.134	0.150
H	2.45	2.60	0.096	0.102
I	0.35	0.85	0.014	0.033
J	0.00	0.10	0.000	0.004

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.4	0.055
B	1.2	0.047
C	3.1	0.122
D	1.9	0.075
E	4.3	0.169

MARKING DIAGRAM



- P/N = Marking Code
- G = Green compound Code
- YW = Date Code
- F = Factory Code

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